## SPECIFICATION FOR LCD MODULE

**MODULE NO: TF-LCM13018A-C-S1** 

Doc.Version:05

		v ei sioii.us	
Customer Appro	oval:		
□ Accept			□ Reject
TOPFOISON	NAME	SIGNATURE	DATE
Prepare	Electronic Engineer	Zhuang wei min 庄伟民	2020-04-07
Check	Mechanical Engineer		
Verify			
Approval		Kuang hao xian 邝浩贤	2020-04-07
☐ APPROVAL	FOR SPECIFICATIONS	ONLY	
□ APPROVAL	FOR SPECIFICATIONS	AND SAMPLE	
			TF-SFLRD01-A0

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## 1. Revision History

Sample Version	DOC. Version	DATE		DESCRIPTION	CHANGED BY
S0	00	2018-02-04	SPEC ONLY	First issue	Harison
S0	01	2018-02-08	SPEC ONLY	Add LCM Assignment No.13	Harison
S0	02	2018-02-23	SPEC ONLY	ADD Touch screen IC Model—page 4	Harison
S0	03	2018-05-10	SPEC ONLY	Modify CTP FPC design	Harison
S1	04	2019-07-10	SPEC ONLY	Replacement of backlight	Harison
S1	05	2020-04-07	SPEC ONLY	Modify FPC pin thickness mark of module—P5	Harison
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			<i>A</i>		
		7			

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## 2. Table of Contents:

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## 3. Module Numbering System:

(Example)

T F -	L C M	3 9 7	0 6 A -	N - V 0	
1	2	3	4 5	6 7	

- (1): TOPFOISON
- 2: LCD Module
- 3: LCD SIZE
- 4: Serial version:00~99, When it goes beyond a hundred bits, it can be raised as: 000~999, and so on
- (5): Customer Version: A~Z.
- 6: T: With Resistive Touch panel
  - C: With Capacitive Touch panel
  - N: Without Touch panel
- 7: S: STD Product
  - V: Customer Made

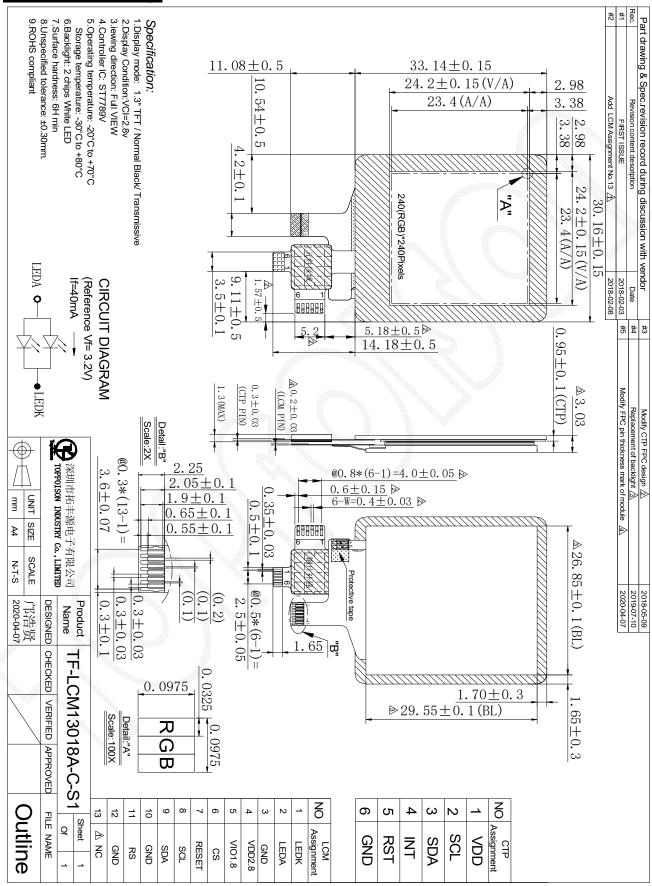
Sample Version: 0~9, When it goes beyond ten bits, it can be raised as: 00~99, and so on.

## 4. General Specification:

ITEM	CONTENTS
Module Size	30.16(W) * 33.14(H) * 3.03(T) mm
Module Size(With FPC)	30.16(W) * 47.32(H) * 3.03(T) mm
Display Size(Diagonal)	1.3 inch
Display Format	240(RGB)*240Pixels
Active Area	23.4(W) * 23.4(H) mm
Pixel Pitch	0.0975*0.0975 mm
LCD Type	Transmissive / Normally Black
View Direction	Free
Controller IC	ST7789V
Touch screen IC	FT6236U

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## 5. LCM drawing:



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## **6. Electrical Characteristics**

## 6-1 Absolute Maximum Ratings

(Ta=25°C VSS=0V)

Item	Symbol	Min.	Type	Max.	Unit	Remark
Supply Voltage	$V_{CI}$	-0.3	-	+4.6	V	Note1
Supply Voltage(Logic)	$IOV_{CC}$	-0.3		+4.6		Note1
Logic Input Voltage Range	V <sub>IN</sub>	0.5		IOVcc +0.5	V	Note1
Operating Temperature	Topr	-20	-	+70	$^{\circ}$ C	-
Storage Temperature	Tstg	-30	-	+80	$^{\circ}$	-

Note1: Absolute maximum rating is the limit value beyond which the IC maybe broken. They do not assure operations.

## **6-2 Operating Conditions**

(Ta=25°C)

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Power Supply voltage	$V_{\mathrm{DD}}$		2.4	2.75	3.3	Volt
Supply voltage for I/O	IOVcc		1.65	1.8	3.3	Volt
Innut Voltage	$V_{\mathrm{IH}}$	-	0.7 IOVcc	1	IOVcc	V
Input Voltage	$V_{\rm IL}$	-	VSS	-	0.3 IOVcc	V
Power Supply Current for LCM	Icc	VCC=2.75V	<b>-</b>	10	-	mA

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## **6-3 Timing Characteristics**

7.4.1 8080 Series MCU Parallel Interface Characteristics: 18/16/9/8-bit Bus

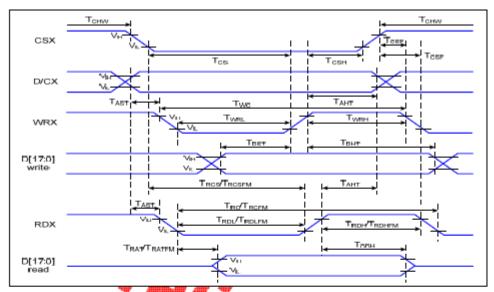


Figure 1 Parallel Interface Timing Characteristics (8080-Series MCU Interface)

VDQ## 65 10., 3.3V, MDD=2.4 to 3.3V, AGND=DGND=0V, Ta= -30 to 70 ℃

Signal	Symbol	Parameter	Min	Max	Unit	Description
D/CX	T <sub>AST</sub>	Address setup time	9	ettin.	ns	
DICX	T <sub>AHT</sub> Address hold time (Write/Read)		16	ń	ns	-
	T <sub>CHW</sub>	Chip select "H" pulse width		74	4	
	T <sub>cs</sub>	Chip select setup time (Write)	15		ns n	
CSX	T <sub>RCS</sub>	Chip select setup time (Read ID)	45	And	ns	
CSA	TROSEM	Chip select setup time (Read FM)	355	•	ns	-
	T <sub>CSF</sub>	Chip select wait time (Write/Read)	10		ns	
	Тсзн	Chip select hold time	10		ns	
	T <sub>wc</sub>	Write cycle	66		ns	
WRX	T <sub>WRH</sub>	Control pulse "H" duration	15		ns	
	T <sub>WRL</sub>	Control pulse "L" duration	15		ns	
	T <sub>RC</sub>	Read cycle (ID)	160		ns	
RDX (ID)	T <sub>RDH</sub>	Control pulse "H" duration (ID)	90		ns	When read ID data
	T <sub>RDL</sub>	Control pulse "L" duration (ID)	45		ns	
RDX	T <sub>RCFM</sub>	Read cycle (FM)	450		ns	When read from
	T <sub>RDHFM</sub>	Control pulse "H" duration (FM)	90		ns	frame memory
(FM) T <sub>RDLFM</sub>		Control pulse "L" duration (FM)	355		ns	marile memory
D[17:0]	T <sub>DST</sub>	Data setup time	10		ns	For CL=30pF
	Трнт	Data hold time	10		ns	
	T <sub>RAT</sub>	Read access time (ID)		40	ns	
	T <sub>RATEM</sub>	Read access time (FM)		340	ns	
	Торн	Output disable time	20	80	ns	

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#### 7.4.3 Serial Interface Characteristics (4-line serial):

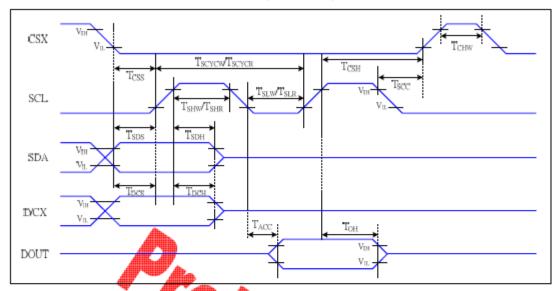


Figure 5 4-line serial Interface Timing Characteristics

V(DD)=1.65 to 3.3V, VDD=2.4 to 3.3V, AGND=DGND=0V, Ta=-30 to 70 ℃

Signal	Symbol	Parameter	MIN	MAX	Unit	Description
	T <sub>CSS</sub>	Chip select setup time (write)	15		ns	
	Тсан	Chip select hold time (wite)	719		ns	
CSX	T <sub>CSS</sub>	Chip select setup time (read)	60		ns	
	T <sub>scc</sub>	Chip select hold time (read)	65		ns a	
	T <sub>CHW</sub>	Chip select "H" pulse width	40	₩ /	ns	
	T <sub>SCYCW</sub>	Serial clock cycle (Write)	66	Ad	ns	-write command & data
	T <sub>SHW</sub>	SCL "H" pulse width (Write)	15		ns	ram
SCL	T <sub>SLW</sub>	SCL "L" pulse width (Write)	15		ns	Tuni
SCL	T <sub>SCYCR</sub>	Serial clock cycle (Read)	150		ns	-read command & data
	T <sub>SHR</sub>	SCL "H" pulse width (Read)	60		ns	ram
	T <sub>SLR</sub>	SCL "L" pulse width (Read)	60		ns	Talli
D/CX	T <sub>DC8</sub>	D/CX setup time	10		ns	
brex	T <sub>DCH</sub>	D/CX hold time	10		ns	
SDA	T <sub>SDS</sub>	Data setup time	10		ns	
(DIN)	T <sub>SDH</sub>	Data hold time	10		ns	
DOUT	T <sub>ACC</sub>	Access time	10	50	ns	For maximum CL=30pF
5001	Тон	Output disable time	15	50	ns	For minimum CL=8pF

Table 6 4-line serial Interface Characteristics

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#### 7.4.4 RGB Interface Characteristics:

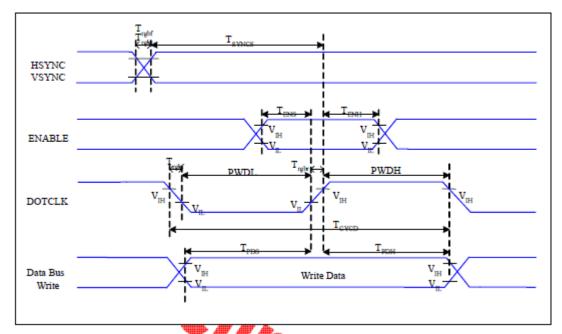


Figure 6 BCB Interface Timing Characteristics

VDD1=1.65.6:8.3V, VDD=2.4 to 3.3V, AGND=DGND=0V, Ta=-30~70 T

Signal	Symbol	Parameter		MAX	Unit	Description
HSYNC, VSYNC	T <sub>SYNCS</sub>	VSYNC, HSYNC Setup Time			ns	
ENABLE	T <sub>ENS</sub>	Enable Setup Time	25		ns	
ENABLE	T <sub>ENH</sub>	Enable Hold Time	25		ns	
	PWDH	DOTCLK High-level Pulse Width	60	-	ns	
DOTCLK	PWDL	DOTCLK Low-level Pulse Width	60	-	ns	
DOTCER	T <sub>CYCD</sub>	DOTCLK Cycle Time	120	-	ns	
	Trghr, Trghf	DOTCLK Rise/Fall time	-	20	ns	
DB	T <sub>PDS</sub>	PD Data Setup Time	50	-	ns	
DB	T <sub>PDH</sub>	PD Data Hold Time	50	-	ns	

Table 7 18/16 Bits RGB Interface Timing Characteristics

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## 7. Optical Characteristics:

Item		Cymbol	Conditions	Spe	cificati	ons	Unit	Note
Item	:	Symbol	Conditions	Min	Тур	Max	Unit	Note
Transmitt (Without		T (%)	-	ı	15.95	ı	ı	-
Contrast l	Ratio	CR	Θ=0 Normal Viewing angle	640	800	-		(1) (2)
Response	time	TR+TF	-	-	30	35	ms	(1) (3)
	Hor	Θx+		-	80	-		
Viewing angle	Hor	Θх-	CR ≥ 10	-	80	-	daa	
	Ver	<b>Θ</b> у+	CK = 10	-	80	80 -	deg.	
	ver	Θу-		-	80	-		

### **Measuring Condition**

1. Measuring surrounding: dark room

2. Ambient temperature: 25±2℃

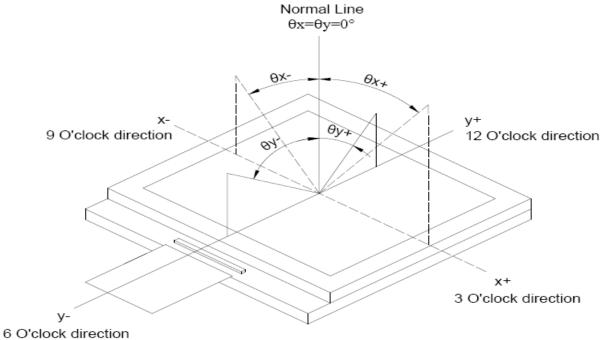
3. 30 min. Warm-up time.

## Color of CIE Coordinate:

Item		Symbol	Condition	Min.	Тур.	Max.
		X		-	0.624	-
	Red	у		-	0.329	-
		x		-	0.288	-
Chromaticity	Green	у	$\theta = \phi = 0^{\circ}$ LED Backlight Color Degree	-	0.522	-
Coordinates	Blue x y x	X		-	0.136	-
(Transmissive)		у		-	0.137	-
		X		-	0.303	-
	White	у		-	0.325	-

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### Note (1) Definition of Viewing Angle:

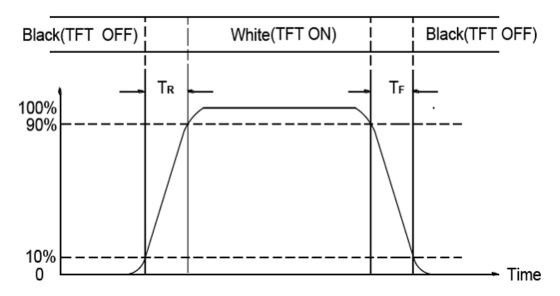


Note (2) Definition of Contrast Ratio (CR): measured at the center point of panel

Contrast ratio (CR)= Photo detector output when LCD is at "White" state

Photo detector output when LCD is at "Black

Note (3) Definition of Response Time: Sum of TR and TF



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## **8. Interface Pin Assignment:**

**LCM Pin Assignment** 

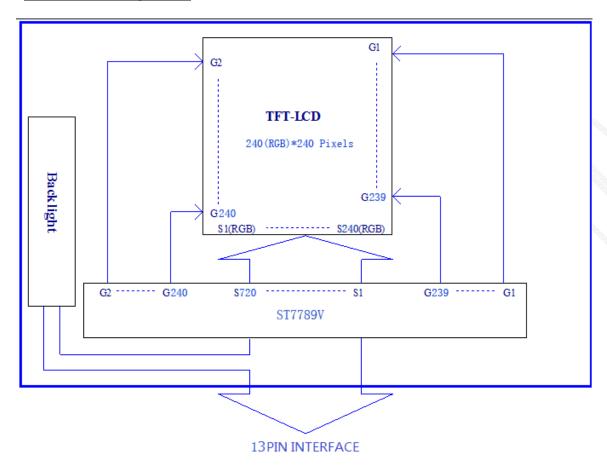
LCM	1 iii Assignment	
No.	Symbol	Function
1	LED-K	Cathode of LED Backlight.
2	LED-A	Anode of LED Backlight.
3	GND	Ground
4	VDD2.8	Power supply for system(2.8v)
5	VIO1.8	Power supply for system(1.8v or 2.8v)
6	CS	Chip selection pin (active low).
7	RESET	RESET PIN
8	SCL	This pin is used to be serial interface clock
9	SDA	Serial data input / output and applied on the rising edge of th SCL signal
10	GND	Ground
11	RS	Data or command select signal input
12	GND	Ground
13	NC	No Connection

**CTP Pin Assignment** 

No.	Symbol	Function
1	VDD	Power supply for system
2	SCL	This pin is used to be serial interface clock
3	SDA	Serial data input / output and applied on the rising edge of th SCL signal
4	INT	Input
5	RST	RESET PIN
6	GND	Ground

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## 9. Block Diagram:



## 10. Backlight:

- 1. Standard Lamp Styles (Edge Lighting Type):
  The LED chips are distributed over the edge light area of the illumination unit, which gives the less power consumption:
- 2. The Main Advantages of the LED Backlight are as following:
  - 2.1 The brightness of the backlight can simply be adjusted. By a resistor or a potentiometer.

3. Data About LED Backlight:

(Ta=25°C)

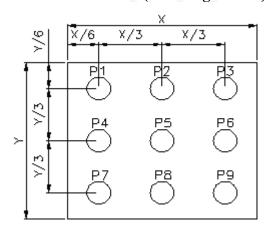
S. Butar recut BEB Buching						(=-	
PARAMETER	Sym.	Min.	Тур.	Max.	Unit	Test Condition	Note
Supply Current	I	-	40	-	mA	V=3.2V	
Supply Voltage	V	2.6	3.2	3.5	V		
Luminous Intensity for LCM	IV	150	180	-	Cd/m <sup>2</sup>	If=20mA	2
Uniformity for LCM	-	70		-	%		3
Life Time	-	20000	-	-	Hr.		4
Color				Wh	ite		

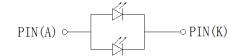
#### NOTE:

- 1. Backlight Only
- 2. Average Luminous Intensity of P1-P9
- 3. Uniformity = Min/Max \* 100%
- 4. LED life time defined as follows: The final brightness is at 50% of original brightness

### Measured Method: (X\*Y: Light Area)

#### **Internal Circuit Diagram**





LED CIRCUIT DIAGRAM:

#### (Effective spatial Distribution)

Using aperture of 1°, distance 50cm.

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# 11. Standard Specification for Reliability: 11–1. Standard Specifications for Reliability of LCD Module

No	Item	Description
01	High temperature operation (高温通电)	The sample should be allowed to stand at 70°C for 48 hours under driving condition and then returning it to normal temperature condition, and allowing it stand for 2 hours.
02	Low temperature operation (低温通电)	The sample should be allowed to stand at -20°C for 48hours under driving condition and then returning it to normal temperature condition, and allowing it stand for 2 hours.
03	High temperature storage (高温存储)	The sample should be allowed to stand at 80°C for 48 hours under no-load condition, and then returning it to normal temperature condition and allowing it stand for 2 hours.
04	Low temperature storage (低温存储)	The sample should be allowed to stand at -30°C for 48 hours under no-load condition, then returning it to normal temperature condition, and allowing it stand for 2 hours.
05	Moisture storage (高温高湿)	The sample should be allowed to stand at 60°C, 90%RH MAX for 48 hours under no-load condition, then taking it out and drying it at normal temperature for 2 hours.
06	Thermal shock storage (冷热冲击)	The sample should be allowed to stand the following 10 cycles: -30°C for 30 minutes → normal temperature for 5 minutes → +80°C for 30 minutes → normal temperature for 5 minutes, as one cycle.
07	Packing vibration (包装震动)	Frequency range: 10Hz ~ 55Hz Amplitude of vibration: 1.5mm X, Y, Z 2 hours for each direction.
08	Packing drop test (跌落实验)	According to ISTA 1A 2001.
09	Electrical Static Discharge	Air: $\pm 4$ KV 150pF/330 $\Omega$ 5 times
	(静电实验)	Contact: ±2KV 150pF/330Ω 5 time

<sup>\*</sup>Sample size for each test item is 1~3pcs

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## 11 - 2. Testing Conditions and Inspection Criteria

For the final test the testing sample must be stored at room temperature for 24 hours, after the tests listed in Table 11-1, Standard specifications for Reliability have been executed in order to ensure stability.

No	Item	Test Model	In section Criteria
01	Current Consumption	Refer To Specification	The current consumption should conform to the product specification.
02	Contrast	Refer To Specification	After the tests have been executed, the contrast must be larger than half of its initial value prior to the tests.
03	Appearance	Visual inspection	Defect free.

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## 12. Specification of Quality Assurance:

#### 12-1. Purpose

This standard for Quality Assurance should affirm the quality of LCD module products to supply to purchaser by TOPFOISON INDUSTRY (Supplier).

#### 12-2. Standard for Quality Test

a. Inspection:

Before delivering, the supplier should take the following tests, and affirm the quality of product.

b. Electro-Optical Characteristics:

According to the individual specification to test the product.

c. Test of Appearance Characteristics:

According to the individual specification to test the product.

d. Test of Reliability Characteristics:

According to the definition of reliability on the specification for testing products.

e. Delivery Test:

Before delivering, the supplier should take the delivery test.

- (i) Test method: According to ISO2859-1. General Inspection Level II take a single time.
- (ii) The defects classify of AQL as following:

Major defect: AQL = 0.65Minor defect: AQL = 2.5Total defects: AQL = 2.5

- 12-3. Non- conforming Analysis & Deal With Manners
  - a. Non-conforming Analysis:
  - (i) Purchaser should supply the detail data of non- conforming sample and the non-conforming.
  - (ii) After accepting the detail data from purchaser, the analysis of non- conforming should be finished in two weeks.
  - (iii) If supplier can not finish analysis on time, must announce purchaser before 3 days.
  - b. Disposition of non-conforming:
    - (i) If find any product defect of supplier during assembly time, supplier must change the good product for every defect after recognition.
    - (ii) Both supplier and customer should analyze the reason and discuss the disposition of non-conforming when the reason of nonconforming is not sure.
- 12-4. Agreement items

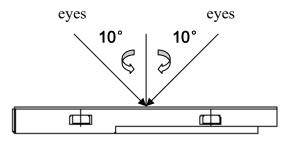
Both sides should discuss together when the following problems happen.

- a. There is any problem of standard of quality assurance, and both sides should think that must be modified.
- b. There is any argument item which does not record in the standard of quality assurance.
- c. Any other special problem.

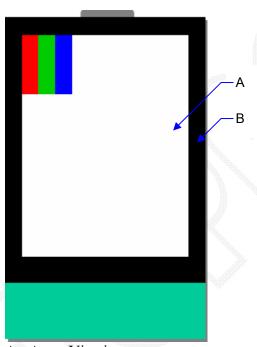
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#### 12-5. Standard of The Product Appearance Test

- a. Manner of appearance test:
- (i) The test must be under  $20W \times 2$  or 40W fluorescent light, and the distance of view must be at  $30\pm5$ cm.
  - (ii) When test the model of transmissive product must add the reflective plate.
  - (iii)The test direction is base on around 10° of vertical line.
  - (iiii)Temperature: 25±5°C Humidity: 60±10%RH



#### (iv) Definition of area:



- A. Area: Viewing area.
- B. Area: Out of viewing area. (Outside viewing area)

#### b. Basic principle:

- (i) It will accord to the AQL when the standard can not be described.
- (ii) The sample of the lowest acceptable quality level must be discussed by both supplier and customer when any dispute happened.
- (iii) Must add new item on time when it is necessary.
- c. Standard of inspection: (Unit: mm)

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12-6. Inspection specification

Defect out of viewing area can be neglected.

NO	Item	rewing area can be ne		iterion		AQL
01	Electrical Testing	1.1 Missing vertical, 1.2 Missing characte 1.3 Display malfunc 1.4 No function or n 1.5 Current consump 1.6 LCD viewing an 1.7 Mixed product ty 1.8 Flicker	er, dot or icon. etion. no display. ption exceeds pagle defect.			0.65
02	Black or White spots or Bright spots or Color spots on LCD (Display only)	<ul><li>2.1 White and black</li><li>Five spots.</li><li>2.2 Densely spaced:</li></ul>	_			2.5
03	LCD and Touch Panel black spots, white spots,	3.1 Round type: As $\Phi = (X+Y)/2$ $X \leftarrow \frac{1}{Y}$ * Densely spaced: 1	No more	Size(mm) $\Phi \le 0.10$ 0.10< $\Phi \le 0.20$ 0.20< $\Phi \le 0.25$ 0.25< $\Phi \le 0.30$ 0.30< $\Phi$ than tw	Acceptable Q'ty Accept no dense  3 2 1 0 0 spots within 3mm.	2.5
	contamination (non – display)	3.2 Line type: (As for which is a second of the second of	Length(mm)  L≤3.0  L≤2.5	width(mm) W≦0.02 0.02 <w≦0.05 0.03<w≦0.15="" 0.15<w<="" td=""><td>Acceptable Q'ty Accept no dense  2 Rejection  to lines within 3mm.</td><td>2.5</td></w≦0.05>	Acceptable Q'ty Accept no dense  2 Rejection  to lines within 3mm.	2.5

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NO	Item	Criterion			
04	Polarizer bubbles	If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction	Size Φ(mm) $\Phi \le 0.20$ $0.20 < \Phi \le 0.50$ $0.50 < \Phi \le 1.00$ $1.00 < \Phi$ Total Q'ty	Acceptable Q'ty Accept no dense  3  2  0 3	2.5
05	Scratches	Follow NO.3 -2 Line Type.			
06	Chipped glass	Symbols: x: Chip length k: Seal width L: Electrode pad length 6.1 General glass chip: 6.1.1 Chip on panel surface and cra  z: Chip thickness  Z≤1/2t  Not over vi area  1/2t< z≤2t  Not exceed  z: Chip thickness  y: Chip width  Not exceed  Not exceed  x  Z≤1/2t  Not over vi area  1/2t< z≤2t  Not over vi area  Not over vi area	x: Chip ewing x≤ the total length of  x: Chip ewing x≤  x: Chip x≤  x: Chip x≤	length 1/8a 1/8a  O Unit:	2.5
		mm  ⊙ If there are 2 or more chips, x is	the total length of	each chip	

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NO	Item	Criterion	AQL
		Symbols: x: Chip length y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: LCD side length L: Electrode pad length 7.2 Protrusion over terminal: 7.2.1 Chip on electrode pad:	
		y: Chip width x: Chip length z: Chip thickness  y≦0.5mm x≦1/8a 0< z≦t	
		7.2.2 Non-conductive portion:	
07	Glass crack	y Z Z Y X Z	2.5
		y: Chip width x: Chip length z: Chip thickness	
		y≦L x≦1/8a 0< z≦t	
		<ul> <li>If there chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications.</li> <li>If the product will be heat sealed by the customer, the alignment mark</li> </ul>	
		must mot be damaged. 7.2.3 Substrate protuberance and internal crack	
		y: width x: length	
		y≦1/3L X≦a	

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NO	Item	Criterion	AQL
08	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
09	Backlight elements	<ul> <li>9.1 Illumination source flickers when lit.</li> <li>9.2 Spots or scratches that appear when lit must be judged. Using LCD spot, lines and contamination standards.</li> <li>9.3 Backlight doesn't light or color is wrong.</li> </ul>	2.5 2.5 0.65
10	Bezel	Bezel must comply with product specifications.	2.5
11	PCB、COB	<ul> <li>11.1 COB seal may not have pinholes larger than 0.2mm or contamination.</li> <li>11.2 COB seal surface may not have pinholes through to the IC.</li> <li>11.3 The height of the COB should not exceed the height indicated in the assembly diagram.</li> <li>11.4 There may not be more than 2mm of sealant outside the seal area on PCB. And there should be no more than three places.</li> <li>11.5 Parts on PCB must be the same as on the production characteristic chart, There should be no wrong parts, missing parts or excess parts.</li> <li>11.6 The jumper on the PCB should conform to the product characteristic chart.</li> </ul>	2.5 2.5 2.5 2.5 0.65
12	FPC	12.1 FPC terminal damage ≤ 1/2 FPC terminal width and can not affect the function, we judge accept.  12.2 FPC alignment hole damage ≤ 1/2 alignment area and can not affect the function, we judge accept.	2.5
13	Soldering	13.1 No cold solder joints, missing solder connections, oxidation or icicle. 13.2 No short circuits in components on PCB or FPC.	2.5 0.65

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NO	Item	Criterion			
		Symbols: x: Chip length k: Seal width length L: Electrode pad length 14.1 General glass claused 14.1.1 Chip on panel	t: Touch Panel Total t		side
			y k x x		
		z: Chip thickness	y: Chip width	x: Chip length	
	Touch Panel	Z≦t	≦1/2 k and not over viewing area	x≦1/8a	
14	Chipped glass	<ul> <li>⊙ Unit: mm</li> <li>⊙ If there are 2 or m</li> <li>14.1.2 Corner crack:</li> </ul>	ore chips, x is the total l	ength of each chip	2.5
		z: Chip thickness	y: Chip width	x: Chip length	
		z≦t	≦1/2 k and not ver viewing area	x≦1/8a	
		<ul><li>⊙ Unit: mm</li><li>⊙ If there are 2 or m</li></ul>	ore chips, x is the total l	ength of each chip	

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NO	Item	Criterion	AQL
15	Touch Panel(Fish eye、dent and bubble on film)	SIZE(mm)Acceptable Q'ty $\Phi \le 0.2$ Accept no dense $0.2 < D \le 0.4$ 5 $0.4 < D \le 0.5$ 2 $0.5 < D$ 0	2.5
16	Touch Panel Newton ring	Newton ring dimension $\leq 1/2$ touch panel area and not affect font and line distortion ( $\leq 2.5\%$ ), it is acceptable.	2.5
17	Touch Panel Linearity	Less than 2.5% is acceptable.	2.5
18	LCD Ripple	Touch the touch panel, can not see the LCD ripple. Pen: R 1.0mm silicon rubber. Operation Force: 80g	2.5
19	General appearance	<ul> <li>19.1 Pin type must match type in specification sheet.</li> <li>19.2 LCD pin loose or missing pins.</li> <li>19.3 Product packaging must the same as specified on packaging specification sheet.</li> <li>19.4 Product dimension and structure must conform to product specification sheet.</li> </ul>	0.65 0.65 0.65 0.65

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## 13. Handling Precaution:

### 13-1 Handling of LCM

- Don't give external shock.
- Don't apply excessive force on the surface.
- Liquid in LCD is hazardous substance. Must not lick and swallow. when the liquid is attach to your hand, skin, cloth etc. Wash it out thoroughly and immediately.
- Don't operate it above the absolute maximum rating.
- Don't disassemble the LCM.
- The operators should be grounded whenever he/she comes into contact with the module. Never touch any of the conductive parts such as the LSI pads, the copper leads on the PCB and the interface terminals with any parts of the human body.
- The modules should be kept in antistatic bags or other containers resistant to static for storage.
- The module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.

#### 13-2 Storage

- Store in an ambient temperature of 25±10°C, and in a relative humidity of 50±10%RH. Don't expose to sunlight or fluorescent light.
- Storage in a clean environment, free from dust, active gas, and solvent.
- Store in anti-static electricity container.
- Store without any physical load.

#### 13-3 Soldering

- Use only soldering irons with proper grounding and no leakage.
- Iron: No higher than 280±10°C and less than 3 sec during Hand soldering.
- Rewiring: no more than 2 times.

## 14. Guarantee:

Our products meet requirements of the environment.

TOPFOISON ROHS requirement is based on European Union Directive 2011/65/EU (ROHS)

Requirements and Update.

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